TOSHIBA 2SC5318

TENTATIVE

TOSHIBA TRANSISTOR SILICON NPN EPITAXIAL PLANAR TYPE

2 S C 5 3 1 8

VHF~UHF BAND LOW NOISE AMPLIFIER APPLICATIONS

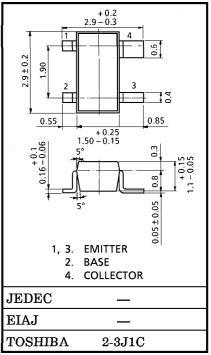
(CHIP: $f_T = 16 \text{ GHz series}$)

Low Noise Figure : NF = 1.3 dB (f = 2 GHz)

High Gain : Ga = 11.5 dB (f = 2 GHz)

MAXIMUM RATINGS (Ta = 25°C)

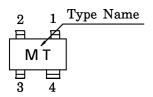
CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector-Base Voltage	v_{CBO}	8	V
Collector-Emitter Voltage	v_{CEO}	5	V
Emitter-Base Voltage	$V_{ m EBO}$	1.5	V
Collector Current	$I_{\mathbf{C}}$	20	mA
Base Current	$I_{\mathbf{B}}$	10	mA
Collector Power Dissipation	$P_{\mathbf{C}}$	150	mW
Junction Temperature	T_{j}	125	°C
Storage Temperature Range	$\mathrm{T_{stg}}$	-55~125	°C



Unit in mm

Weight: 0.012 g

MARKING



MICROWAVE CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Transition Frequency	${ m f_T}$	$V_{ m CE}=3~{ m V},~{ m I}_{ m C}=15~{ m mA}$	13	16	_	GHz
Incontion (ioin	$ S_{21e} ^2$ (1)	$V_{CE} = 3 \text{ V}, I_{C} = 15 \text{ mA}, f = 1 \text{ GHz}$	14.5	17	_	dB
	$ S_{21e} ^2$ (2)	$V_{CE} = 3 V, I_{C} = 15 mA, f = 2 GHz$	8.5	11.5	_	
Noise Figure	NF (1)	$V_{CE} = 3 V$, $I_{C} = 5 mA$, $f = 1 GHz$		0.9	1.8	dB
	NF (2)	$V_{ m CE}=3~{ m V},~{ m I}_{ m C}=5~{ m mA},~{ m f}=2~{ m GHz}$		1.3	2.2	

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ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Collector Cut-off Current	ICBO	$V_{CB} = 8 V, I_{E} = 0$	_	_	1	μ A
Emitter Cut-off Current	I_{EBO}	$V_{EB} = 1 V, I_{C} = 0$	_	_	1	μ A
DC Current Gain	$h_{ ext{FE}}$	$V_{CE} = 3 \text{ V}, I_{C} = 15 \text{ mA}$	50	_	250	V
Output Capacitance	C_{ob}	$V_{CB} = 2.5 \text{ V}, I_{E} = 0,$	_	0.6	_	pF
Reverse Transfer Capacitance	$\mathrm{C_{re}}$	f = 1 MHz (Note)	_	0.4	0.85	pF

(Note): C_{re} is measured by 3 terminal method with Capacitance Bridge.

CAUTION

This device electrostatic sensitivity. Please handle with caution.